

12 A Three-quadrant triacs high commutation Rev. 01 — 16 April 2007

Product data sheet

Product profile

1.1 General description

Passivated, new generation, high commutation triacs in a SOT78 plastic package

1.2 Features

- Sensitive gate
- Very high commutation performance maximized at each gate sensitivity
- High immunity to dV/dt

1.3 Applications

- High power motor control e.g. washing
 Refrigeration and air conditioning machines, vacuum cleaners
- Electronic thermostats

compressors

1.4 Quick reference data

- $V_{DRM} \le 600 \text{ V (BTA312-600D)}$
- $V_{DRM} \le 600 \text{ V (BTA312-600E)}$
- $V_{DRM} \le 800 \text{ V (BTA312-800E)}$
- $I_{TSM} \le 95 \text{ A (t = 20 ms)}$
- $I_{GT} \le 5 \text{ mA (BTA312-600D)}$
- $I_{GT} \le 10 \text{ mA (BTA312-600E)}$
- $I_{GT} \le 10 \text{ mA (BTA312-800E)}$
- $I_{T(RMS)} \le 12 A$

Pinning information

Table 1. **Pinning**

Pin	Description	Simplified outline	Symbol
1	main terminal 1 (T1)	mb	N. 1
2	main terminal 2 (T2)		T2—T1
3	gate (G)		`G sym051
mb	mounting base; main terminal 2 (T2)		
		SOT78 (TO-220AB)	



3. Ordering information

Table 2. Ordering information

Type number	Package				
	Name	Description	Version		
BTA312-600D	SC-46	plastic single-ended package; heatsink mounted; 1 mounting hole;	SOT78		
BTA312-600E		3-lead TO-220AB			
BTA312-800E					

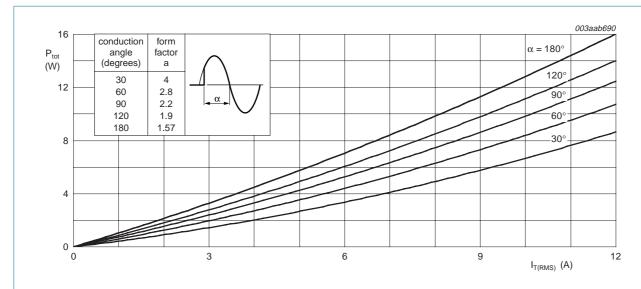
4. Limiting values

Table 3. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

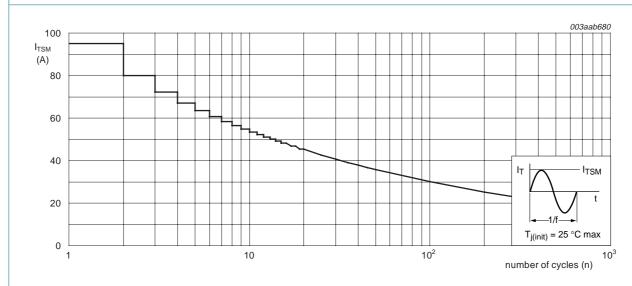
Symbol	Parameter	Conditions	Min	Max	Unit
V_{DRM}	repetitive peak off-state voltage	BTA312-600D; BTA312-600E	<u>[1]</u> _	600	V
		BTA312-800E	-	800	V
$I_{T(RMS)}$	RMS on-state current	full sine wave; $T_{mb} \le 101$ °C; see Figure 4 and 5	-	12	Α
I _{TSM}	non-repetitive peak on-state current	full sine wave; $T_j = 25$ °C prior to surge; see Figure 2 and 3			
		t = 20 ms	-	95	Α
		t = 16.7 ms	-	105	Α
I ² t	I ² t for fusing	t = 10 ms	-	45	A ² s
dl _T /dt	rate of rise of on-state current	$I_{TM} = 20 \text{ A}; I_G = 0.2 \text{ A};$ $dI_G/dt = 0.2 \text{ A}/\mu\text{s}$	-	100	A/μs
I_{GM}	peak gate current		-	2	Α
P_{GM}	peak gate power		-	5	W
$P_{G(AV)}$	average gate power	over any 20 ms period	-	0.5	W
T _{stg}	storage temperature		-40	+150	°C
T _i	junction temperature		-	125	°C

^[1] Although not recommended, off-state voltages up to 800 V may be applied without damage, but the triac may switch to the on-state. The rate of rise of current should not exceed 15 A/μs.



 α = conduction angle

Fig 1. Total power dissipation as a function of RMS on-state current; maximum values



f = 50 Hz

Fig 2. Non-repetitive peak on-state current as a function of the number of sinusoidal current cycles; maximum values

(1) dl_T/dt limit

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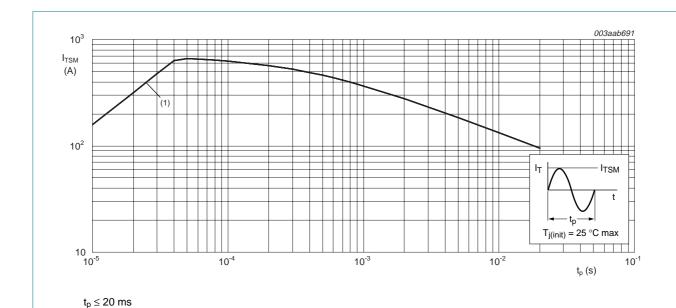


Fig 3. Non-repetitive peak on-state current as a function of pulse duration; maximum values

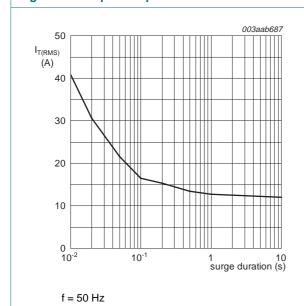


Fig 4. RMS on-state current as a function of surge duration; maximum values

 $T_{mb} = 101~^{\circ}C$

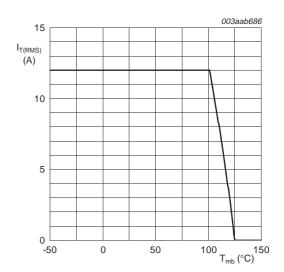


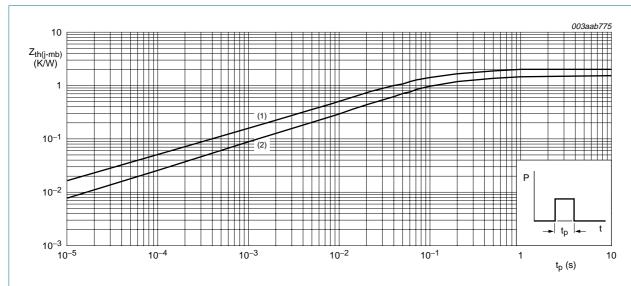
Fig 5. RMS on-state current as a function of mounting base temperature; maximum values

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5. Thermal characteristics

Table 4. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-mb)}$	thermal resistance from junction to mounting base	half cycle; see Figure 6	-	-	2.0	K/W
		full cycle; see Figure 6	-	-	1.5	K/W
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	-	60	-	K/W



- (1) Unidirectional (half cycle)
- (2) Bidirectional (full cycle)

Fig 6. Transient thermal impedance from junction to mounting base as a function of pulse duration

6. Static characteristics

Table 5. Static characteristics

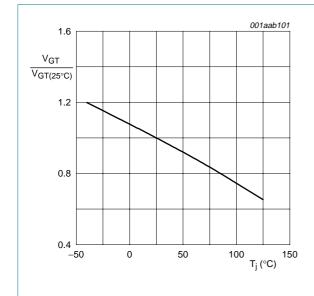
 $T_i = 25 \,^{\circ}C$ unless otherwise specified.

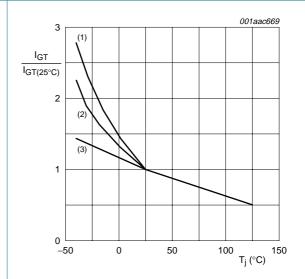
Parameter	Conditions		BTA312-600D			BTA312-600E BTA312-800E		
		Min	Тур	Max	Min	Тур	Max	
gate trigger	$V_D = 12 \text{ V; } I_T = 0.1 \text{ A; see } \frac{\text{Figure 8}}{}$	•						
current	T2+ G+	-	-	5	-	-	10	mA
	T2+ G-	-	-	5	-	-	10	mA
	T2- G-	-	-	5	-	-	10	mA
latching current	V _D = 12 V; I _{GT} = 0.1 A; see <u>Figure 10</u>							
	T2+ G+	-	-	10	-	-	25	mA
	T2+ G-	-	-	15	-	-	30	mA
	T2- G-	-	-	15	-	-	25	mA
holding current	$V_D = 12 \text{ V; } I_{GT} = 0.1 \text{ A; see } \frac{\text{Figure } 11}{\text{Figure } 11}$	-	-	10	-	-	15	mA
on-state voltage	I _T = 15 A; see <u>Figure 9</u>	-	1.3	1.6	-	1.3	1.6	V
gate trigger	$V_D = 12 \text{ V; } I_T = 0.1 \text{ A; see } \frac{\text{Figure 7}}{}$	-	0.7	1.5	-	0.7	1.5	V
voltage	$V_D = 400 \text{ V}; I_T = 0.1 \text{ A}; T_j = 125 ^{\circ}\text{C}$	0.25	0.4	-	0.25	0.4	-	V
off-state current	$V_D = V_{DRM(max)}$; $T_j = 125 ^{\circ}C$	-	0.1	0.5	-	0.1	0.5	mΑ
	gate trigger current latching current holding current on-state voltage gate trigger voltage	$ \begin{array}{c} \text{gate trigger} \\ \text{current} \end{array} \begin{array}{c} V_D = 12 \ \text{V; I}_T = 0.1 \ \text{A; see } \underline{\text{Figure 8}} \\ \hline T2 + G + \\ \hline T2 + G - \\ \hline T2 - G - \\ \\ \text{latching current} \end{array} \begin{array}{c} V_D = 12 \ \text{V; I}_{GT} = 0.1 \ \text{A; see } \underline{\text{Figure 10}} \\ \hline T2 + G + \\ \hline T2 + G - \\ \hline T2 - G - \\ \\ \text{holding current} \end{array} \begin{array}{c} V_D = 12 \ \text{V; I}_{GT} = 0.1 \ \text{A; see } \underline{\text{Figure 11}} \\ \\ \text{on-state} \\ \text{voltage} \end{array} \begin{array}{c} V_D = 12 \ \text{V; I}_T = 0.1 \ \text{A; see } \underline{\text{Figure 9}} \\ \\ V_D = 12 \ \text{V; I}_T = 0.1 \ \text{A; see } \underline{\text{Figure 7}} \end{array} $			$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	$ \begin{array}{ c c c c c c } \hline \text{Min} & \text{Typ} & \text{Max} & \text{Min} & \text{Typ} & \text{Max} \\ \hline \text{Min} & \text{Typ} & \text{Max} & \text{Min} & \text{Typ} & \text{Max} \\ \hline \text{Min} & \text{Typ} & \text{Max} & \text{Min} & \text{Typ} & \text{Max} \\ \hline \text{Min} & \text{Typ} & \text{Max} & \text{Min} & \text{Typ} & \text{Max} \\ \hline \text{Min} & \text{Typ} & \text{Max} & \text{Min} & \text{Typ} & \text{Max} \\ \hline \text{Min} & \text{Typ} & \text{Max} & \text{Min} & \text{Typ} & \text{Max} \\ \hline \text{Min} & \text{Typ} & \text{Max} & \text{Min} & \text{Typ} & \text{Max} \\ \hline \text{Min} & \text{Typ} & \text{Max} & \text{Min} & \text{Typ} & \text{Max} \\ \hline \text{Min} & \text{Typ} & \text{Max} & \text{Min} & \text{Typ} & \text{Max} \\ \hline \text{Min} & \text{Typ} & \text{Max} & \text{Min} & \text{Typ} & \text{Max} \\ \hline \text{Min} & \text{Typ} & \text{Max} & \text{Min} & \text{Typ} & \text{Max} \\ \hline \text{Min} & \text{Typ} & \text{Max} & \text{Min} & \text{Typ} & \text{Max} \\ \hline \text{Min} & \text{Typ} & \text{Max} & \text{Min} & \text{Typ} & \text{Max} \\ \hline \text{Min} & \text{Typ} & \text{Max} & \text{Min} & \text{Typ} & \text{Max} \\ \hline \text{Min} & \text{Typ} & \text{Max} & \text{Min} & \text{Typ} & \text{Max} \\ \hline \text{Min} & \text{Typ} & \text{Max} & \text{Min} & \text{Typ} & \text{Max} \\ \hline \text{Min} & \text{Typ} & \text{Max} & \text{Min} & \text{Typ} & \text{Max} \\ \hline \text{Min} & \text{Typ} & \text{Max} & \text{Min} & \text{Typ} & \text{Max} \\ \hline \text{Min} & \text{Typ} & \text{Max} & \text{Min} & \text{Typ} & \text{Max} \\ \hline \text{Min} & \text{Typ} & \text{Max} & \text{Min} & \text{Typ} & \text{Max} \\ \hline \text{Min} & \text{Typ} & \text{Max} & \text{Sin} & \text{Constant } \\ \hline \text{Min} & \text{Typ} & \text{Max} & \text{Sin} & \text{Constant } \\ \hline \text{Min} & \text{Typ} & \text{Max} & \text{Min} & \text{Typ} & \text{Max} \\ \hline \text{Min} & \text{Typ} & \text{Max} & \text{Sin} & \text{Constant } \\ \hline \text{Min} & \text{Typ} & \text{Max} & \text{Sin} & \text{Constant } \\ \hline \text{Min} & \text{Typ} & \text{Max} & \text{Min} & \text{Typ} & \text{Max} \\ \hline \text{Min} & \text{Typ} & \text{Max} & \text{Min} & \text{Typ} & \text{Max} \\ \hline \text{Min} & \text{Typ} & \text{Max} & \text{Min} & \text{Typ} & \text{Max} \\ \hline \text{Min} & \text{Typ} & \text{Max} & \text{Min} & \text{Min} & \text{Min} & \text{Min} & \text{Min} \\ \hline \text{Min} & \text{Min} \\ \hline \text{Min} & Min$

7. Dynamic characteristics

Table 6. Dynamic characteristics

Symbol	Parameter	Conditions	BTA312-600D			BTA312-600E BTA312-800E			Unit
				Тур	Max	Min	Тур	Max	
dV _D /dt	rate of rise of off-state voltage	$V_{DM} = 0.67 \times V_{DRM(max)}$; $T_j = 125$ °C; exponential waveform; gate open circuit	20	-	-	50	-	-	V/μs
of comi	rate of change of	$V_{DM} = 400 \text{ V}$; $T_j = 125 ^{\circ}\text{C}$; $I_{T(RMS)} = 12 \text{ A}$; without snubber; gate open circuit	1	-	-	3	-	-	A/ms
	commutating current	$V_{DM} = 400 \text{ V}; T_j = 125 ^{\circ}\text{C}; I_{T(RMS)} = 12 \text{ A};$ dV/dt = 10 V/ μ s; gate open circuit	1.5	-	-	6	-	-	A/ms
		$V_{DM} = 400 \text{ V}; T_j = 125 ^{\circ}\text{C}; I_{T(RMS)} = 12 \text{ A};$ dV/dt = 1 V/ μ s; gate open circuit	4.5	-	-	10	-	-	A/ms
t _{gt}	gate-controlled turn-on time	I_{TM} = 20 A; V_D = $V_{DRM(max)}$; I_G = 0.1 A; dI_G/dt = 5 A/ μs	-	2	-	-	2	-	μs





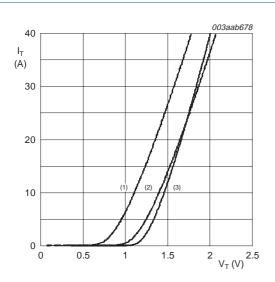
- (1) T2-G-
- (2) T2+ G-
- (3) T2+ G+

Fig 7. Normalized gate trigger voltage as a function of junction temperature

Fig 8. Normalized gate trigger current as a function of junction temperature

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 $V_0 = 1.127 \text{ V}$

 $R_s = 0.027 \Omega$

(1) $T_j = 125 \,^{\circ}\text{C}$; typical values

(2) T_i = 125 °C; maximum values

(3) $T_j = 25$ °C; maximum values

Fig 9. On-state current as a function of on-state voltage

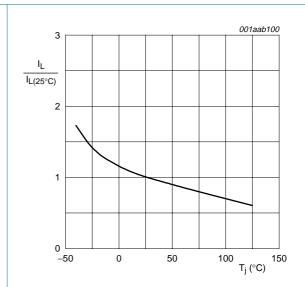


Fig 10. Normalized latching current as a function of junction temperature

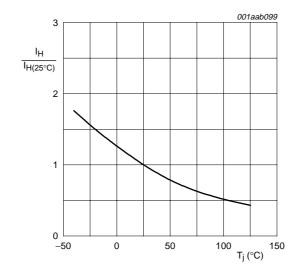


Fig 11. Normalized holding current as a function of junction temperature

Package outline 8.

Plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB

SOT78

ISSUE DATE

05-03-22

PROJECTION

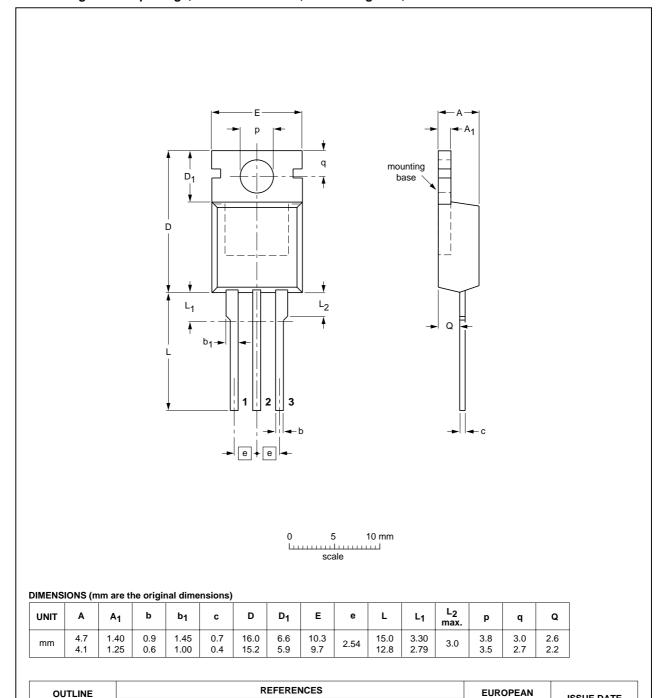


Fig 12. Package outline SOT78 (3-lead TO-220AB)

IEC

JEDEC

3-lead TO-220AB

VERSION

SOT78

JEITA

SC-46

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9. Revision history

Table 7. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BTA312_SER_D_E_1	20070416	Product data sheet	-	-

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10. Legal information

10.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
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